

APPROVAL SHEET

RFDIP Series - 1608(0603) - RoHS Compliance

MULTILAYER CERAMIC DIPLEXER

Halogens Free Product

2400 ~ 2500 / 5150 ~ 7125 MHz Working Frequency

P/N: RFDIP1607CLM6T39

*Contents in this sheet are subject to change without prior notice.

FEATURES

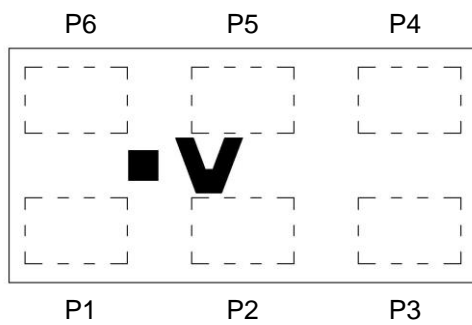
1. Miniature footprint: 1.6 X 0.8 X 0.7 mm³
2. Low Insertion Loss
3. High attenuation on harmonic suppressed
4. LTCC process

APPLICATIONS

1. 2400 ~ 2500 / 5150 ~ 7125 MHz working frequency

CONSTRUCTION

Top View



PIN	Connection
P1	High Band
P2	GND
P3	Low Band
P4	GND
P5	Common Port
P6	GND

DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	1.60 ± 0.10
	W	0.80 ± 0.10
	T	0.7 max.
	A	0.35 ± 0.05
	B	0.22 ± 0.05
	C	0.225 ± 0.05
	D	0.22 ± 0.05

ELECTRICAL CHARACTERISTICS

RFDIP1607CLM6T39	Specification	
Frequency range	2400~2500 MHz	5150~7125 MHz
Insertion Loss (at +25°C)	1.14 dB typ.	1.27 dB typ. @ 5150~5950 MHz 1.75 dB typ. @ 5950~7125 MHz
Attenuation	17.6 dB typ. @ 1164~1300 MHz 22.8 dB typ. @ 1559~1601 MHz 23.1 dB typ. @ 3600~4000 MHz 31.7 dB typ. @ 4800~7100 MHz 28.8 dB typ. @ 7200~7500 MHz 42.9 dB typ. @ 9600~10000 MHz	55.7 dB typ. @ 824~849 MHz 47.2 dB typ. @ 1164~1600 MHz 47.2 dB typ. @ 1601~2400 MHz 52.9 dB typ. @ 2400~2500 MHz 46.8 dB typ. @ 2501~3299 MHz 31.1 dB typ. @ 3300~4200 MHz 1.5 dB typ. @ 4400~4800 MHz 7.5 dB typ. @ 7680~8000 MHz 26.2 dB typ. @ 8288~9400 MHz 30.2 dB typ. @ 9400~14250 MHz 26.7 dB typ. @ 14700~21375 MHz
Isolation	50.7 dB typ. @ 2400~2500 MHz 32.2 dB typ. @ 4800~7100 MHz	
Return loss	14.6 dB typ.	11.5 dB typ. @ 5150~5950 MHz 11.5 dB typ. @ 5950~7125 MHz
Impedance	50 Ω	
Power Capacity	3.0W max.	
Moisture sensitivity levels	MSL is LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)	
HBM ESD	Pass 1KV on all pins (Base on AEC-Q200-002)	
MM ESD	Pass 200V (Base on EIA/JESD22-A115)	

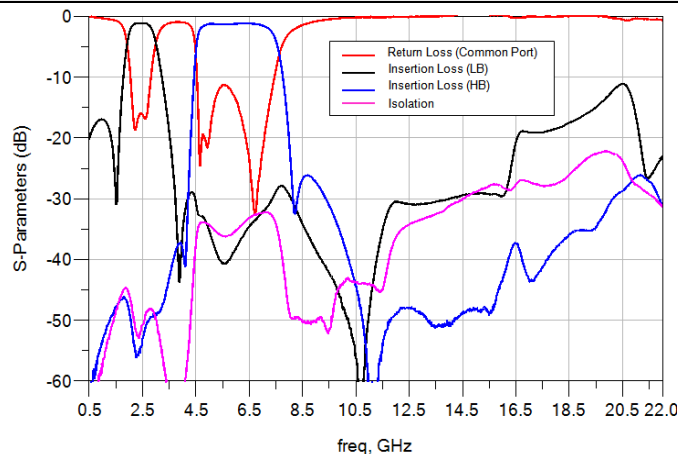
Operating & Storage Condition (Component)

Operation Temperature Range: -40 ~ +85 °C
Storage Temperature Range: -40 ~ +85 °C

Storage Condition before Soldering (Included packaging material)

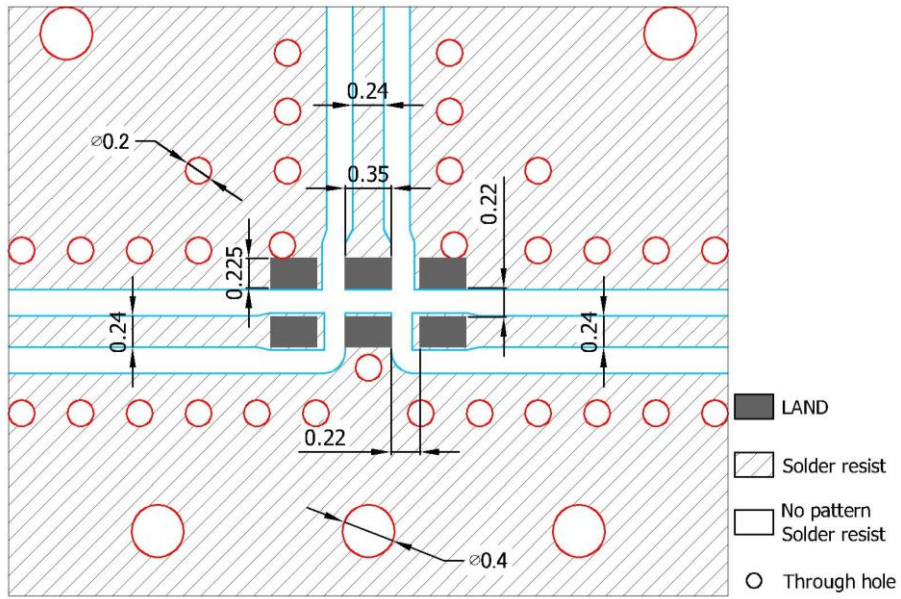
Storage Temperature Range: +5 ~ +40 °C
Humidity: 30 to 70% relative humidity

TYPICAL ELECTRICAL PERFORMANCE



LAND PATTERN

Figure



Unit : mm

Line width to be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.

RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}\text{C}$ *Immersion time : 2 ± 0.5 sec Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : $120\sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature : $270\pm 5^{\circ}\text{C}$ *Immersion time : 10 ± 1 sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044 Customer's specification.	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each units : 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.
Vibration JIS C 0040	*Frequency : $10\text{Hz}\sim 55\text{Hz}\sim 10\text{Hz}(1\text{min})$ *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N (LGA terminal series) ; $5\text{N}(\leq 0603)$; $10\text{N}(>0603)$ *Test time : 10 ± 1 sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.

Temperature cycle JIS C 0025	<ol style="list-style-type: none"> 1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity : 90% to 95% R.H. *Temperature : 40±2°C *Time : 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2, This product could sustain by reflow process three times, and the temperature below 260°C.

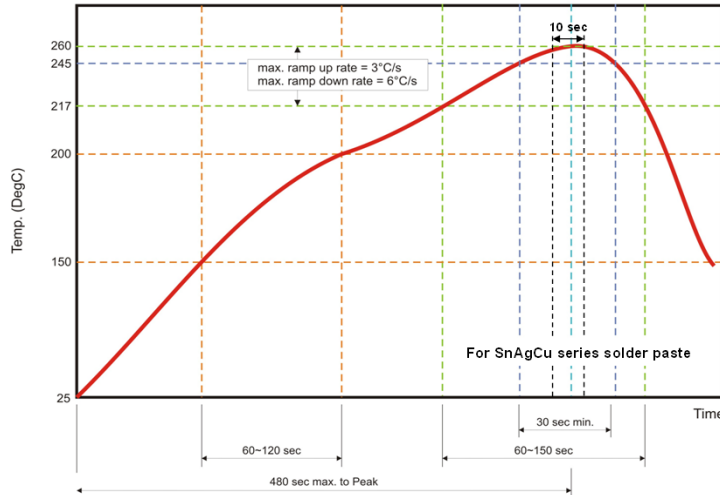


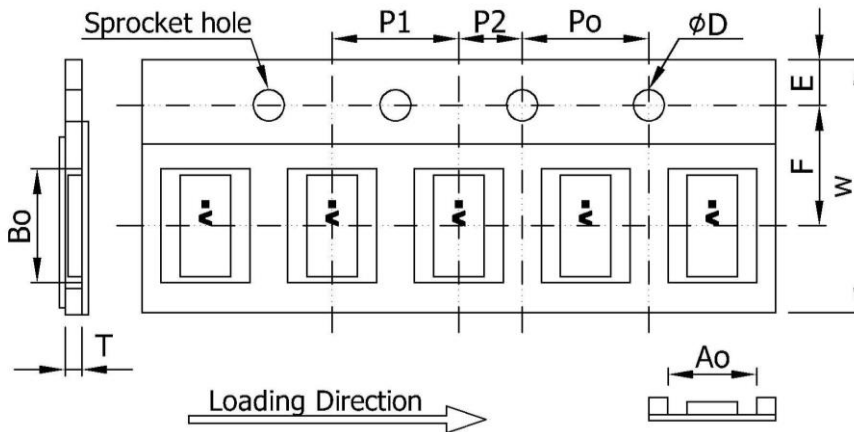
Fig 2. Infrared soldering profile

ORDERING CODE

RF Walsin RF device	DIP Product Code DIP :Diplexer	1607 Dimension code Per 2 digits of Length, Width, Thickness : e.g. : 16 = Length 1.6 mm, Width 0.8 mm, 07 = Thickness 0.7 mm	C Pin Define Design code	L Application L : 2400~2500 MHz / 5150~7125 MHz	M6T39 Specification Design code
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Minimum Ordering Quantity: 4000 pcs per reel.

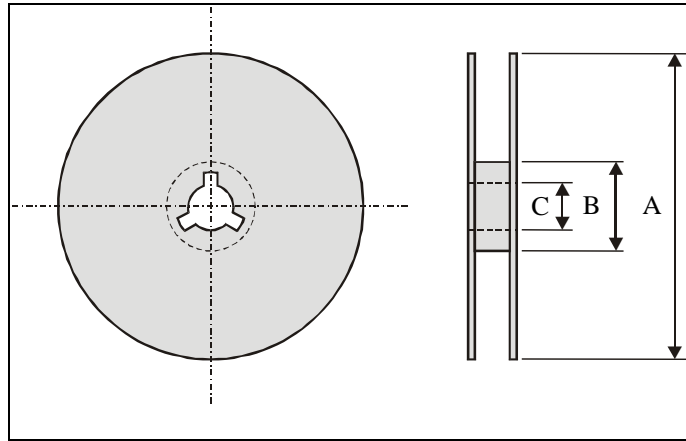
PACKAGING



Paper Tape specifications (unit :mm)

Index	Ao	Bo	φD	T	W
Dimension (mm)	0.975 ± 0.10	1.76 ± 0.10	1.55 ± 0.05	0.75 ± 0.10	8.00 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05

Reel dimensions



Index	A	B	C
Dimension (mm)	Φ178.0	Φ60.0	Φ13.0

Taping Quantity: 4000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.
 - Temperature : +5 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be storage under the airtight packaged condition.

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